

# Data Sheet



## CMA3000-D01 3-AXIS ULTRA LOW POWER ACCELEROMETER WITH DIGITAL SPI AND I<sup>2</sup>C INTERFACE

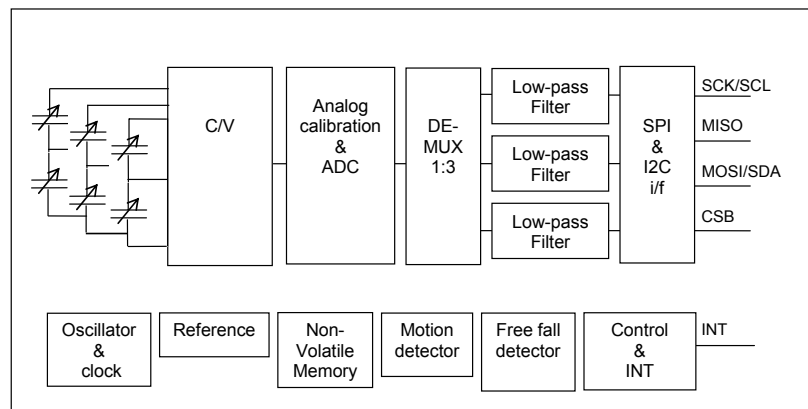
### Features

- 1.7 V – 3.6 V supply voltage
- SPI and I<sup>2</sup>C digital interface
- User selectable
  - ±2 g and ±8 g measurement ranges
  - sample rate & frequency response
- Ultra low current consumption
  - ≤ 70 uA with 100/400 Hz sample rate
  - ≤ 11 uA with 40/10Hz sample rate
- Interrupt signal triggered by data ready, motion and free fall
- Size 2x2x0.95 mm<sup>3</sup>
- Proven capacitive 3D-MEMS technology
- High shock durability
- RoHS compliant / lead free soldering

### Applications

CMA3000-D01 is targeted to battery operated devices. Typical applications are but not limited

- Gaming input devices
- Computer peripherals
- Free fall detection
- Activity monitoring



**Figure 1** CMA3000-D01 Block Diagram

## Performance Characteristics <sup>1)</sup>

Parameter	Condition	Typical supply range 1.7 – 2.7 V			Extended supply range 2.7 – 3.6 V			Units
		Min	Typ <sup>2)</sup>	Max	Min	Typ <sup>2)</sup>	Max	
Vdd		1.7	2.5	2.7	-	3.3	-	V
Digital I/O Vdd	Vdd ≥ Digital I/O Vdd	1.7	1.8 / 2.5	2.7	-	3.3	-	V
Operating temperature **		-40	-	85	-40	-	85	°C
Current consumption *	ODR=400 Hz	-	70	90	-	70	-	µA
	ODR=100 Hz	-	50	-	-	50	-	
	ODR=40 Hz	-	11	-	-	14	-	
	ODR=10 Hz	-	7	-	-	9	-	
	Power down	-	4	9	-	3	-	
Acceleration range *	G_RANGE bit 0	-8	-	8	-	±8	-	G
	G_RANGE bit 1	-2	-	2	-	±2	-	
Offset calibration error * <sup>3)</sup>	G_RANGE bit 1	-100	±25	+100	-	±100	-	mg
Offset temperature error ** <sup>4)</sup>	-40 ... +85 °C							
	X and Z axis		±1		-	±1	-	mg/°C
	Y axis		±2.5		-	±2.5	-	
Sensitivity * <sup>5)</sup>	Full scale = 2 g	-	56	-	-	56	-	Count/g
	Full scale = 8 g	-	14	-	-	14	-	
Sensitivity calibration error *		-10	-	+10	-	±10	-	%
Sensitivity temperature error ** <sup>6)</sup>	-40 ... +85 °C	-	±0.02		-	±0.02	-	%/°C
Non-Linearity ** <sup>7)</sup>		-	1.5	3	-	1.5	-	% FS
Cross-Axis sensitivity ** <sup>8)</sup>	G_RANGE bit 1	-	1	-	-	1	-	%
Output Data Rate, ODR **	MODE bits x10		400		-	400	-	Hz
	MODE bits x01		100			100		
	MODE bits 011		40			40		
	MODE bits 100		10			10		
Bandwidth ** <sup>9)</sup>			ODR/5			ODR/5	-	Hz
Noise ** <sup>10)</sup>	Full scale=2 g, ODR=100 Hz	-	13		-	13	-	mg RMS
	Full scale=8 g, ODR=400 Hz	-	25		-	25	-	
Turn on time ** <sup>11)</sup>	ODR=400 Hz	-	0.01		-	0.01	-	s
	ODR≤100 Hz	-	2.5/ODR		-	2.5/ODR	-	
I <sup>2</sup> C clock rate **		-	-	400	-	-	400	kHz
SPI clock rate **				500			500	kHz

\* 100% tested in production

\*\* Qualified during product validation

1) The product is factory calibrated at 2.5 V in room temperature.

2) Typical values are not guaranteed.

3) Z-axis +1g position. Soldering process can cause offset shift which is typically less than 150 mg. Please see TN68\_CMA3000\_Assembly\_Instructions for further details.

4) Offset temperature error = {Count(0g)-Offset} / Sensitivity [ g ]. Sensitivity = Calibrated sensitivity. Offset= Calibrated offset.

5) Sensitivity = {Count(+1g) - Count(-1g)}/2 [Count/g].

6) Sensitivity temperature error = {[Count(+1g)-Count(-1g)]/2 - Sensitivity} / Sensitivity x 100% [%]. Sensitivity = Calibrated sensitivity.

7) Best fit straight line.

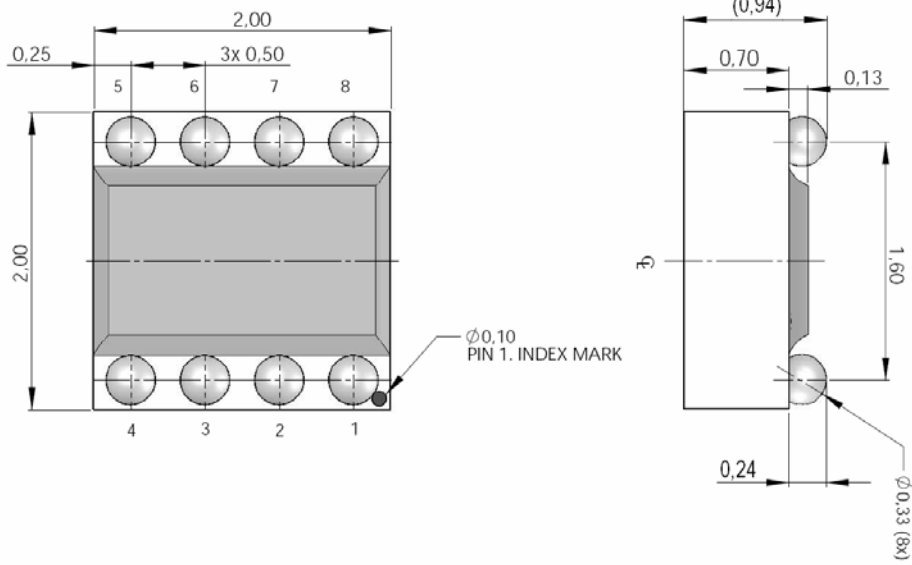
8) The cross-axis sensitivity determines how much acceleration, perpendicular to the measuring axis, couples to the output. The total cross-axis sensitivity is the geometric sum of the sensitivities of the two axes which are perpendicular to the measuring axis. The angular alignment error between X, Y and Z axis is included into the cross axis sensitivity.

9) Frequency responses with 1<sup>st</sup> order roll off according to Figure 3.

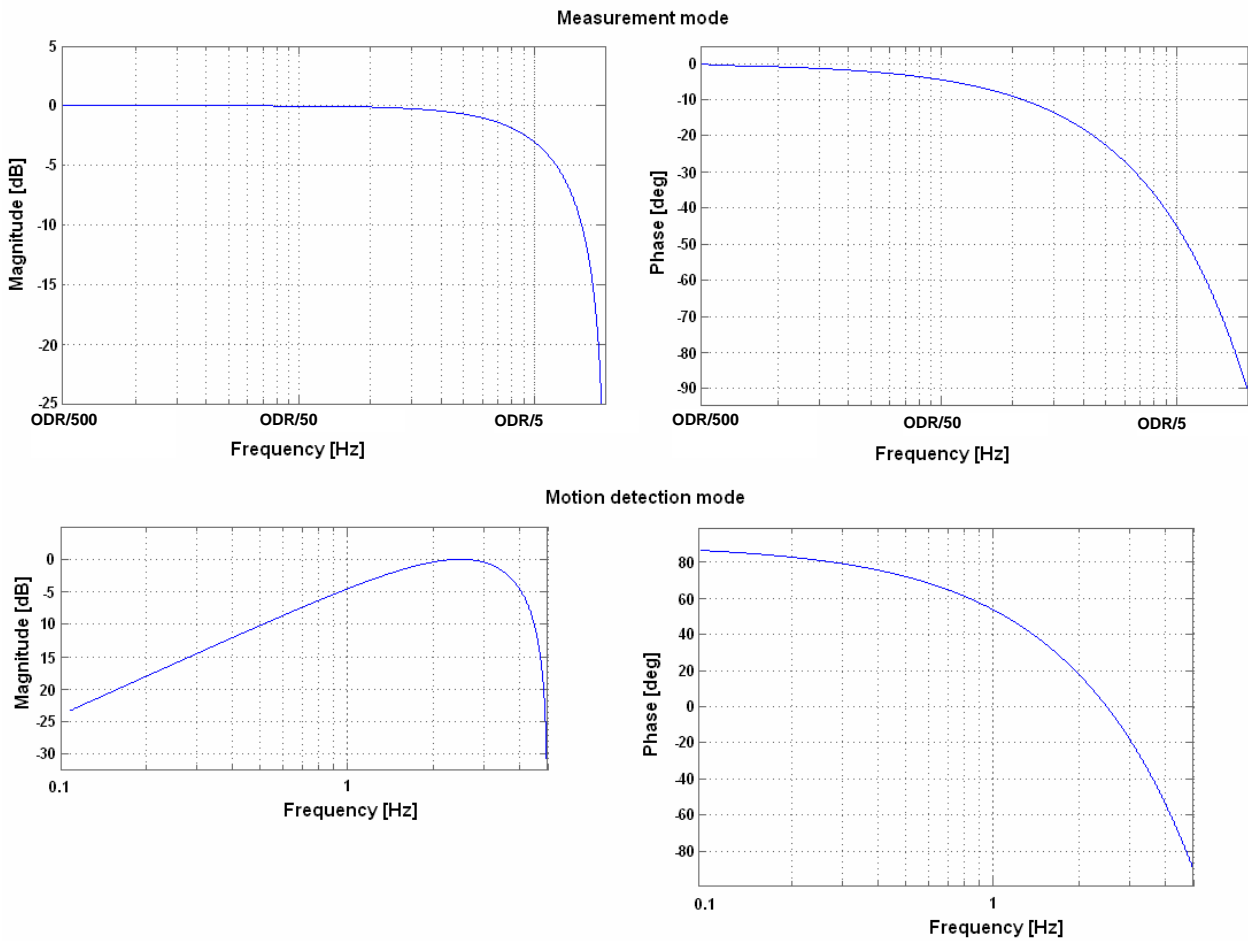
10) Average noise/axis over the measurement bandwidth defined as  $\sqrt{\frac{1}{3}(n_x^2 + n_y^2 + n_z^2)}$ , where  $n_x$ ,  $n_y$  and  $n_z$  are

the measured signal's standard deviation due to noise in x, y and z directions.

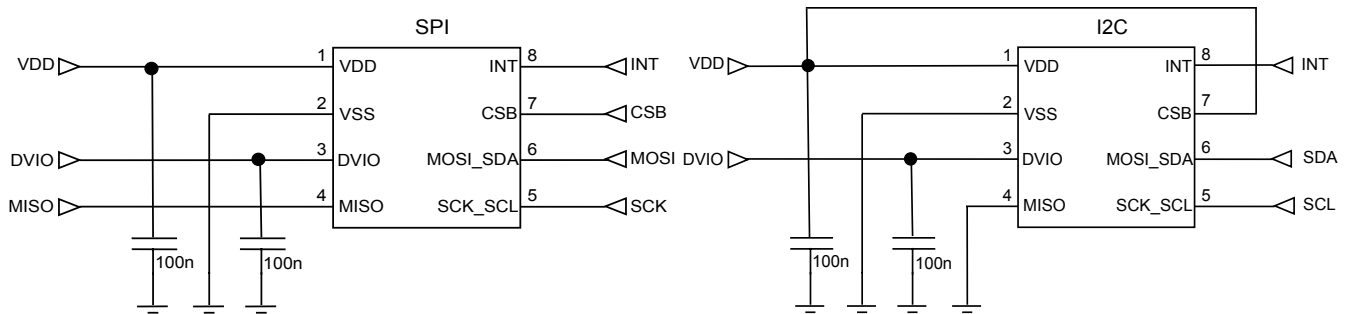
11) Settling error less than 1% of FS.



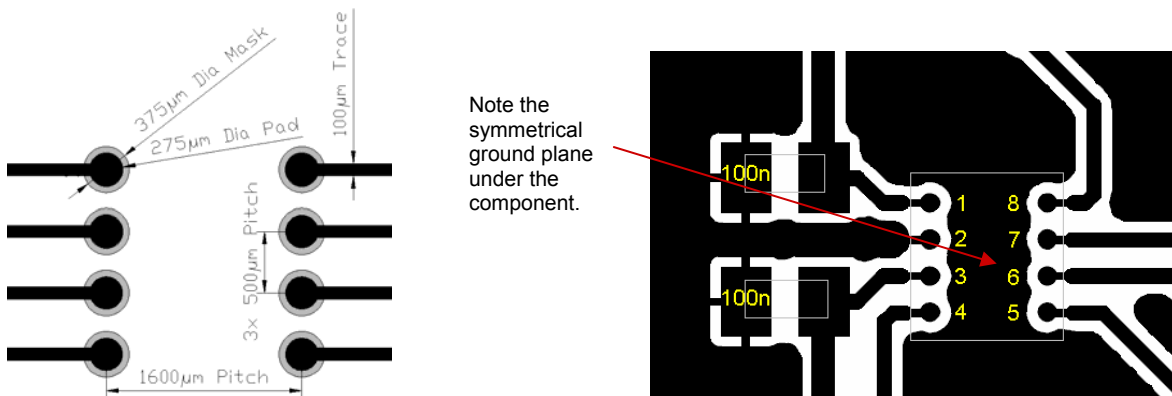
**Figure 2** Package dimensions in mm with  $\pm 50 \mu\text{m}$  tolerance.



**Figure 3** Typical Frequency responses of CMA3000-D01.



**Figure 4** Application schematics for SPI and I<sup>2</sup>C bus



**Figure 5** Recommended layout pattern (not actual size, for reference only)

**Table 1** Pin descriptions

Pin #	Name	Function
1	VDD	Supply voltage
2	VSS	Ground
3	DVIO	I/O Supply
4	MISO	SPI Serial Data Output (MISO)
5	SCK_SCL	SPI Serial Clock (SCK) / I <sup>2</sup> C Serial Clock (SCL)
6	MOSI_SDA	SPI Serial Data Input (MOSI) / I <sup>2</sup> C Serial Data (SDA)
7	CSB	Chip select / I <sup>2</sup> C enable
8	INT	Interrupt

## Document Change Control

Rev.	Date	Change Description
0.1	02-May-07	1 <sup>st</sup> version
...	...	...
0.7	14-Feb-08	Performance characteristics update
0.8	21-Apr-08	Target values for offset and sensitivity, non-linearity and cross axis added.
0.9	01-Jul-08	Figure 1 & Table 1 pin names corrected, Figure 2,3 & 5 updated
0.10	28-Aug-08	Current consumption, sensitivity and sensitivity temperature error, non-linearity, cross axis sensitivity and noise updated.
0.11	01-Sep-08	8g range noise level corrected.
0.12	10-Dec-08	Performance characteristics and notes updated. Figure 2 updated.
0.13	29-Dec-08	Version for launch
0.14	12-Jun-09	Performance characteristics update